QQQX2.E72873
Electrically Isolated Semiconductor Devices - Component

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IXYS SEMICONDUCTOR GMBH E72873
Edisonstrasse 15
68623 Lampertheim, GERMANY

Electrically Isolated Semiconductor Device, Model(s) GBO25-12NO1, GBO25-16NO1

Power Switching Semi-Conductors, "ISOPLUS-247 package", Model(s) C, D, I or M followed by additional numbers and letters, followed by HI, HJ, HQ or HR.

Power Switching Semi-Conductors, "ISOPLUS-247 package", Model(s) CS or DS followed by up to 10 numbers and letters, followed by R.

Power Switching Semi-Conductors, "ISOPLUS-i4", Model(s) C, D, I or M followed by two letters, followed by additional numbers and letters, followed by FB, FC, FD or FE.

Power switching semi-conductors, "ISOPLUS-i4", Model(s) CS#

Power Switching Semi-Conductors, "ISOPLUS-i4", Model(s) CS, DH, DS followed by up to 15 numbers and letters, followed by F or F1.

Power switching semi-conductors, "ISOPLUS-i4", Model(s) DS#, DSE#, FBE#, FBO#, FBS#, FCC#, FCD#, FDC#, FDD#, FDI#, FDM#, FEE#, FID#, FII#, FIO#, FMD#, FMK#, FMM#, FRR#, FSS#, FUE#, FUO#, FUS#, IXBF#, IXDF#, IXEF#, IXFF#, IXGF#, IXKF#, IXLF#, IXSF#, IXUF#

Power Switching Semi-Conductors, "ISOPLUS220 package", Model(s) C, D, I or M followed by additional numbers and letters, followed by PI or PJ.

Power Switching Semi-Conductors, "ISOPLUS220 package", Model(s) CS, DS or DG followed by numbers and letters, followed by C.

Power switching semi-conductors, Model(s) 40370-32*

Power Switching Semi-Conductors, Model(s) C, D, I or M followed by two letters, followed by additional numbers and letters, followed by NA.

Power Switching Semi-Conductors, Model(s) C, D, I, and M followed by numbers and/or letters, followed by GU, GV, GW, GX, GY or GZ.

Power Switching Semi-Conductors, Model(s) C, D, I, and M followed by numbers and/or letters, followed by LA, LB, LC, or LD.

Power Switching Semi-Conductors, Model(s) CS followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) D followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) D, C, M or I followed by additional letters and/or numbers, followed by PN or PM.

Power Switching Semi-Conductors, Model(s) DS followed by additional letters and/or numbers, followed by M.

Power switching semi-conductors, Model(s) DSEI....P, DSEK....P

Power Switching Semi-Conductors, Model(s) GUO followed by numbers, followed by "-", followed by numbers, followed by NO1.

Power Switching Semi-Conductors, Model(s) ISOPLUS-264 Models C, D, I or M, followed by two letters, followed by additional numbers and letters, followed by KI, KJ, KK, KL, KM, KN ,KO, KP, KQ, KR, KS, KT, KU, KV. Models IXBL, IXFL, IXTL or LKK, followed by additional numbers and letters

Power Switching Semi-Conductors, Model(s) IX (single phase) followed by two numbers, followed by MB, followed by three numbers.

Power Switching Semi-Conductors, Model(s) IX (three phase) followed by two numbers, followed by MT, followed by three numbers.

Power Switching Semi-Conductors, Model(s) IX followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) M followed by two letters, followed by additional numbers and letters, followed by JA, JB, JC, JD or JE.

Power Switching Semi-Conductors, Model(s) MC and M followed by two letters, followed by additional numbers or letters, followed by VB or VC.

Power Switching Semi-Conductors, Model(s) MC, MD, MI or MM followed by two letters, followed by additional numbers and letters, followed by ED, EH, SF, or SH.

Power Switching Semi-Conductors, Model(s) MC, MD, MI or MM followed by two letters, followed by additional numbers and letters, followed by ML or MH.

Power Switching Semi-Conductors, Model(s) MC, MD, MI or MM followed by two letters, followed by additional numbers and letters, followed by TA, TB, TC, TD, TE, TF, or TG.

Power Switching Semi-Conductors, Model(s) MC, MD, MI or MM followed by two letters, followed by additional numbers and letters, followed by VA.

Power Switching Semi-Conductors, Model(s) MC, MD, MI or MM followed by two letters, followed by additional numbers and letters, followed by YA, YB, YC, YD, YE,YF, YI, YJ, YK or YL.

Power Switching Semi-Conductors, Model(s) MC, MD, MI, and MM followed by 8 to 10 alphanumeric characters, followed by MI.

Power Switching Semi-Conductors, Model(s) MC, MD, MI, and MM followed by 8 to 10 alphanumeric characters, followed by SA.

Power Switching Semi-Conductors, Model(s) MC, MD, MI, and MM followed by 8 to 11 alphanumeric characters, followed by CA, CB, CC, CD, CE, CF, CG, CH.

Power Switching Semi-Conductors, Model(s) MC, MD, MI, or MM followed by two letters, followed by additional numbers and letters, followed by KA, KB, KC, KD or KE.

Power Switching Semi-Conductors, Model(s) MC, MD, MI, or MM followed by two letters, followed by additional numbers or letters, ending with VH.

Power Switching Semi-Conductors, Model(s) MCC, MCD, MCK, MDC, or MDD followed by 120 through 200.*

Power Switching Semi-Conductors, Model(s) MCC, MCD, MDA, MDC, or MDD followed by numbers between 19 and 100.*

Power Switching Semi-Conductors, Model(s) MCC, MCD, MDC, or MDD followed by 170 through 350.*

Power switching semi-conductors, Model(s) MCC165*, MCC220*, MCC250*, MCC310*, MCD165*, MCD220*, MCD250*, MCD310*

Power switching semi-conductors, Model(s) MCO or MDO, followed by 400 through 650.*

Power switching semi-conductors, Model(s) MDC165*, MDC220*, MDC250*, MDC310*, MDD165*, MDD220*, MDD250*, MDD310*

Power Switching Semi-Conductors, Model(s) MDI followed by 90 through 1550*

Power switching semi-conductors, Model(s) MDI, MID or MII, followed by 20 through 150.*

Power Switching Semi-Conductors, Model(s) MEA, MEE, MEK, MPK or MEO followed by numbers between 50 and 240.*

Power Switching Semi-Conductors, Model(s) MEA, MEE, MEK, or MEO followed by 150 through 600.*

Power Switching Semi-Conductors, Model(s) MID followed by 90 through 1550*

Power Switching Semi-Conductors, Model(s) MIE followed by 90 through 1550*

Power Switching Semi-Conductors, Model(s) MII followed by 90 through 1550*

Power Switching Semi-Conductors, Model(s) MIO followed by 90 through 1550*

Power switching semi-conductors, Model(s) MIO, VIO or VMO, followed by 200 through 1200.*

Power switching semi-conductors, Model(s) MLO 100*, MLO 36*, MLO 50*, MLO 75*, MLO....7, MMO 36*, MMO 50*, MMO 75*

Power Switching Semi-Conductors, Model(s) MMO, MCO, MCD followed by additional numbers, followed by io1 or io6.

Power switching semi-conductors, Model(s) MMO....7

Power Switching Semi-Conductors, Model(s) MUBW, MWI or MKI followed by additional numbers and/or letters, followed by 7or 8, may be followed by T.

Power Switching Semi-Conductors, Model(s) MUBW, MWI, or MKI followed by additional numbers and /or letters, followed by 6K.

Power Switching Semi-Conductors, Model(s) MWI followed by additional numbers and/or letters, followed by 9.

Power Switching Semi-Conductors, Model(s) MWI followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power Switching Semi-Conductors, Model(s) VBBW followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VBE*, VBE.. .NO7

Power Switching Semi-Conductors, Model(s) VBEF followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power Switching Semi-Conductors, Model(s) VBH followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VBO or VUO, followed by 10 through 125.*

Power switching semi-conductors, Model(s) VBO or VUO, followed by 50 through 100.*

Power switching semi-conductors, Model(s) VBO...7, VBO...NO7, VBO13*, VBO14*, VBO15*, VBO16*, VBO17*, VBO18*, VBO19*, VBO20*, VBO21*, VBO22*, VBO23*, VBO24*, VBO25*, VBO26*, VBO27*, VBO28*, VBO29*, VBO30*, VBO31*, VBO32*, VBO33*, VBO34*, VBO35*, VBO36*, VCA....7, VCC....7, VCD....7, VCK....7, VCO....7

Power Switching Semi-Conductors, Model(s) VDD may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VDI followed by 90 through 1550*

Power switching semi-conductors, Model(s) VDI....P1, VDI100*, VDI25*, VDI50*, VDI75*, VEE*, VGO....7, VH013*, VH014*, VH015*, VH016*, VH017*, VH018*, VH019*, VH020*, VH021*, VH022*, VH023*, VH024*, VH025*, VH026*, VH027*, VH028*, VH029*, VH030*, VH031*, VH032*, VH033*, VH034*, VH035*, VH036*, VHF*, VHF....7, VHF13*, VHF14*, VHF15*, VHF16*, VHF17*, VHF18*, VHF19*, VHF20*, VHF21*, VHF22*, VHF23*, VHF24*, VHF25*, VHF26*, VHF27*, VHF28*, VHF29*, VHF30*, VHF31*, VHF32*, VHF33*, VHF34*, VHF35*, VHF36*, VHFD*, VHM...7, VHO....7

Power Switching Semi-Conductors, Model(s) VID followed by 90 through 1550*

Power Switching Semi-Conductors, Model(s) VID may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power switching semi-conductors, Model(s) VID....P1, VID100*, VID25*, VID50*, VID75*

Power Switching Semi-Conductors, Model(s) VIE followed by 90 through 1550*

Power Switching Semi-Conductors, Model(s) VII followed by 90 through 1550*

Power switching semi-conductors, Model(s) VII....7, VII....P1, VII100*, VII25*, VII50*, VII75*, VIO....P1, VK013*, VK014*, VK015*, VK016*, VK017*, VK018*, VK019*, VK020*, VK021*, VK022*, VK023*, VK024*, VK025*, VK026*, VK027*, VK028*, VK029*, VK030*, VK031*, VK032*, VK033*, VK034*, VK035*, VK036*, VKI....7, VKI....P1, VKM...7, VKO....7

Power Switching Semi-Conductors, Model(s) VMD may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VMH may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VMK, VMM, or VMO followed by numbers between 25 and 250.*

Power Switching Semi-Conductors, Model(s) VMM followed by 90 through 1550*

Power Switching Semi-Conductors, Model(s) VMM may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power switching semi-conductors, Model(s) VMO....P1, VTO....7

Power Switching Semi-Conductors, Model(s) VUB followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VUB*

Power Switching Semi-Conductors, Model(s) VUB, VUO, or VVZB followed by additional numbers and/or letters, followed by NO1, NOX or ioX, may be followed by T.

Power switching semi-conductors, Model(s) VUB...P1, VUB...PO1, VUBM....P1

Power Switching Semi-Conductors, Model(s) VUBW followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VUC*

Power Switching Semi-Conductors, Model(s) VUC15 may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VUC25 may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VUC36 may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power switching semi-conductors, Model(s) VUCB*, VUE*, VUE.. .NO7, VUI*, VUI....N7

Power Switching Semi-Conductors, Model(s) VUM followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VUM*, VUM.....N7

Power Switching Semi-Conductors, Model(s) VUM24 may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VUM33 may be followed by 15, 24, 25, 33, or 36, followed by 05, 12, 14, 16, 500, 1200, 1400, or 1600, may be followed by G02, E, N01, N, PH *

Power Switching Semi-Conductors, Model(s) VUO followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VUO*, VUO...7, VUO...NO7, VUO30*, VUO50*, VUO60*

Power Switching Semi-Conductors, Model(s) VVBW followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VVY*, VVY12*, VVY24*, VVY40*

Power Switching Semi-Conductors, Model(s) VVZ followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VVZ*, VVZ....7, VVZ12*, VVZ24*, VVZ40*

Power Switching Semi-Conductors, Model(s) VVZB followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VW2X*, VW3....7, VWI....P1

Power Switching Semi-Conductors, Model(s) VWM followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VWM....7

Power Switching Semi-Conductors, Model(s) VWO followed by additional numbers and/or letters, followed by A5, DL1, iol, io2, ioX, NO1, NO2, or NOX, may be followed by T

Power switching semi-conductors, Model(s) VWO....7, VZI....P1

Power switching semi-conductors, package SOT-227B, miniBloc, Model(s) DH1X*, DH2X*, DSEI*, DSEP*, DSI*, DSS*, IXDN*, IXEN*, IXFN*, IXGN*, IXKN*, IXLN*, IXSN*, IXTN*, IXUN*, VBE*, VBO*, VBS*

Semi-conductor diodes, thyristors, IGBTs or MOSFETS, "ISOPLUS-247 package", Model(s) IXDR%, IXER%, IXFR%, IXKR%

Semi-conductor diodes, thyristors, IGBTs or MOSFETS, "ISOPLUS220 package", Model(s) IXKC*

- Followed by up to 15 numbers and letters.

% - Followed by up to 10 numbers and letters.

* - May be followed by additional numbers or letters.

Marking: Company name or trademark IXYS, and model designation.

Last Updated on 2017-12-08

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IXYS CORP E153432
1590 BUCKEYE DR
MILPITAS, CA 95035-7418 USA

Power Switching Semi-Conductors, Model(s) CS followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) D followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) D, C, M or I followed by additional letters and/or numbers, followed by PN or PM.

Power Switching Semi-Conductors, Model(s) DS followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) IX followed by additional letters and/or numbers, followed by M.

Power Switching Semi-Conductors, Model(s) IX followed by an upper case letter, followed by N, followed by any number 01 through 99999, followed by additional numbers and letters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISO247 package, Model(s) IX J Series IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by J, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS I4-PAC package, Model(s) IX F Series IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by F, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS SMPD package, Model(s) IXM2001 IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by L, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS SMPD package, Model(s) MDIX4X30N65B3 IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by L, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS SMPD package, Model(s) MMIX IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by L, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS SMPD package, Model(s) MMIX1992 IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by L, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS220 package, Model(s) IX followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by C, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, ISOPLUS264 package, Model(s) IX L Series IX, followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by L, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

Semi-conductor diodes, thyristors, IGBT or MOSFETS, SSMPD package, Model(s) MMJX MMJX, followed by 1, 2, 3, followed by B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by number 1-999, followed by N or P, followed by number 1-800, may be followed by up to 6 alpha-numeric characters.

Semi-conductor diodes, thyristors, or MOSFETS, 247 hole-less package, Model(s) DSE (a), IXBR (a), IXGR (a), IXLR (a), IXSR (a), IXTR (a)

Semi-conductor diodes, thyristors, or MOSFETS, ISOPLUS247 package, Model(s) IX followed by one letter B, C, D, E, F, G, H, K, L, S, T, U, X, or Y, followed by R, may be followed by 01-09, 1R1-1R9, 1-9, 10-99, or 100-999 may be followed by N or P, may be followed by 01-10, 1-99 or 100-800, may be followed by up to six alpha-numeric characters.

(a) - Followed by up to 10 numbers and letters.

Marking: Company name and model designation.

Last Updated on 2018-08-29

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IXYS

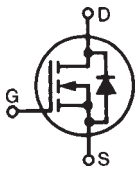
PolarHV™ HiPerFET Power MOSFET ISOPLUS247™

(Electrically Isolated Back Surface)

IXFR 180N15P

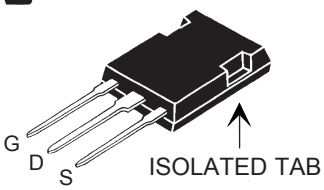
N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Diode

V_{DSS} = 150 V
I_{D25} = 100 A
$R_{DS(on)}$ ≤ 13 mΩ
t_{rr} ≤ 200 ns



Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	T_J = 25° C to 175° C	150	V
V_{DGR}	T_J = 25° C to 175° C; R_{GS} = 1 MΩ	150	V
V_{GSS}	Continuous	±20	V
V_{GSM}	Transient	±30	V
I_{D25}	T_C = 25° C	100	A
$I_{D(RMS)}$	External Lead current limit	75	A
I_{DM}	T_C = 25° C, pulse width limited by T_{JM}	380	A
I_{AR}	T_C = 25° C	60	A
E_{AR}	T_C = 25° C	100	mJ
E_{AS}	T_C = 25° C	4	J
dv/dt	$I_S \le I_{DM}$, di/dt ≤100 A/μs, $V_{DD} \le V_{DSS}$, T_J ≤150° C, R_G = 4 Ω	10	V/ns
P_D	T_C = 25° C	300	W
T_J		-55 ... +175	°C
T_{JM}		175	°C
T_{stg}		-55 ... +150	°C
T_L	1.6 mm (0.062 in.) from case for 10 s	300	°C
V_{ISOL}	50/60 Hz, RMS, 1 minute	2500	V~
F_d	Mounting force	20..120 / 4.5..26	N/lb
Weight		5	g

ISOPLUS247 (IXFR)
E153432



G = Gate D = Drain
S = Source

Symbol (T_J = 25° C, unless otherwise specified)	Test Conditions	Characteristic Values Min.	Typ.	Max.	
V_{DSS}	V_{GS} = 0 V, I_D = 250 μA	150			V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = 4 mA	2.5		5.0	V
I_{GSS}	V_{GS} = ±20 V_{DC}, V_{DS} = 0			±100	nA
I_{DSS}	$V_{DS} = V_{DSS}$, V_{GS} = 0 V			25	μA
	T_J = 150° C			1.5	mA
$R_{DS(on)}$	V_{GS} = 10 V, $I_D = I_T$, Note 1			13	mΩ

Features

- International standard isolated package
- UL recognized package
- Silicon chip on Direct-Copper-Bond substrate
  - High power dissipation
  - Isolated mounting surface
  - 2500V electrical isolation
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect
- Fast intrinsic diode

Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions (T_J = 25° C, unless otherwise specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	V_{DS} = 10 V; I_D = I_T, Notes 1, 2	55	86		S
C_{iss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		7000		pF
C_{oss}			2250		pF
C_{rss}			515		pF
$t_{d(on)}$	V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS}, I_D = 60A R_G = 3.3 Ω (External)		30		ns
t_r			32		ns
$t_{d(off)}$			150		ns
t_f			36		ns
$Q_{g(on)}$	V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS}, I_D = I_T		240		nC
Q_{gs}			55		nC
Q_{gd}			140		nC
R_{thJC}				0.5	°C/W
R_{thCS}			0.15		°C/W

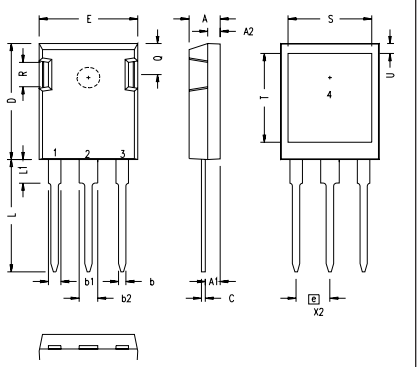
Source-Drain Diode

Symbol	Test Conditions (T_J = 25° C, unless otherwise specified)	Characteristic Values min.	typ.	max.	
I_S	V_{GS} = 0 V			180	A
I_{SM}	Repetitive			380	A
V_{SD}	I_F = I_S, V_{GS} = 0 V, Note 1			1.5	V
t_{rr}	I_F = 25A, -di/dt = 100 A/μs			200	ns
Q_{RM}	V_R = 100V, V_{GS} = 0V		0.6		μC
I_{RM}			6		A

Notes:

1. Pulse test, t ≤300 μs, duty cycle d ≤ 2 %;
2. Test current I_T = 90 A.

ISOPLUS247 Outline



SYM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	.190	.205	4.83	5.21
A1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
b	.045	.055	1.14	1.40
b1	.075	.084	1.91	2.13
b2	.115	.123	2.92	3.12
C	.024	.031	0.61	0.80
D	.819	.840	20.80	21.34
E	.620	.635	15.75	16.13
e	.215 BSC		5.45 BSC	
L	.780	.800	19.81	20.32
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	.190	4.32	4.83
S	.520	.540	13.21	13.72
T	.620	.640	15.75	16.26
U	.065	.080	1.65	2.03

1 – GATE
2 – DRAIN (COLLECTOR)
3 – SOURCE (EMITTER)
4 – NO CONNECTION

NOTE: This drawing will meet all dimensions requirement of JEDEC outline TO-247AD except screw hole.

Fig. 1. Output Characteristics @ 25ºC

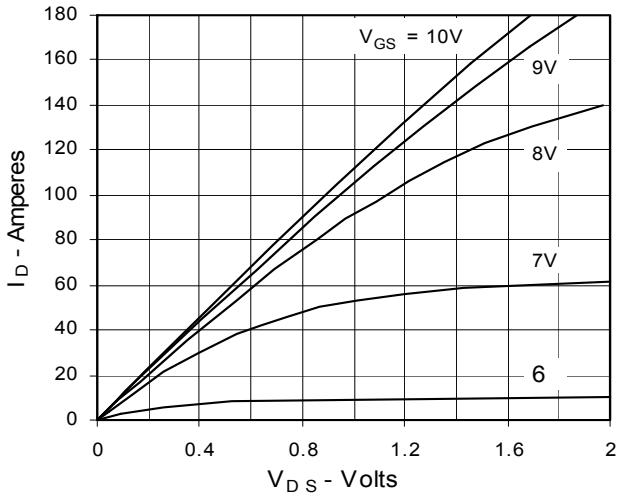


Fig. 2. Extended Output Characteristics @ 25ºC

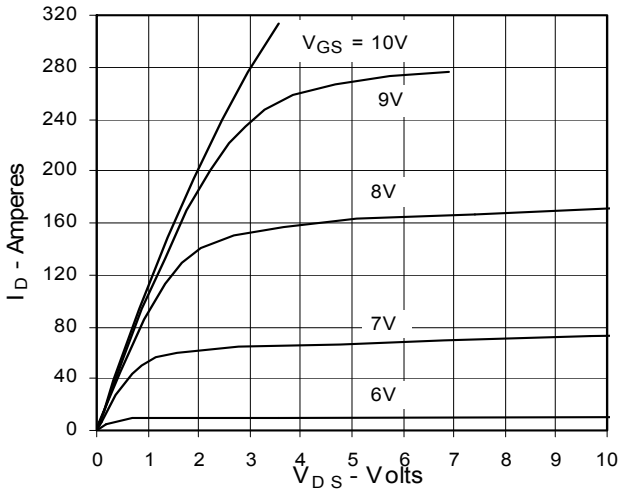


Fig. 3. Output Characteristics @ 150ºC

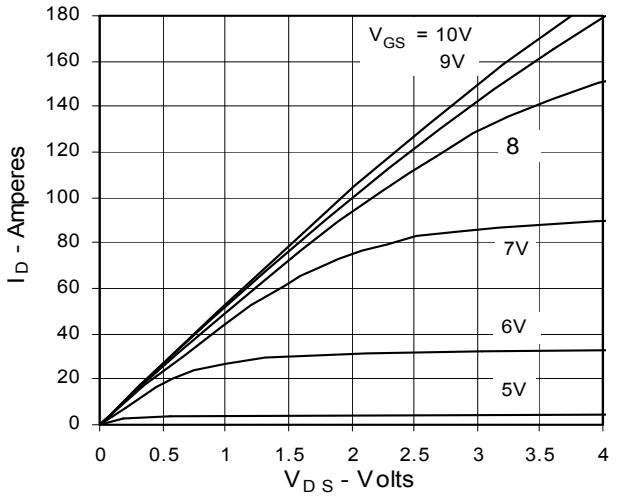


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 90A Value vs. Junction Temperature

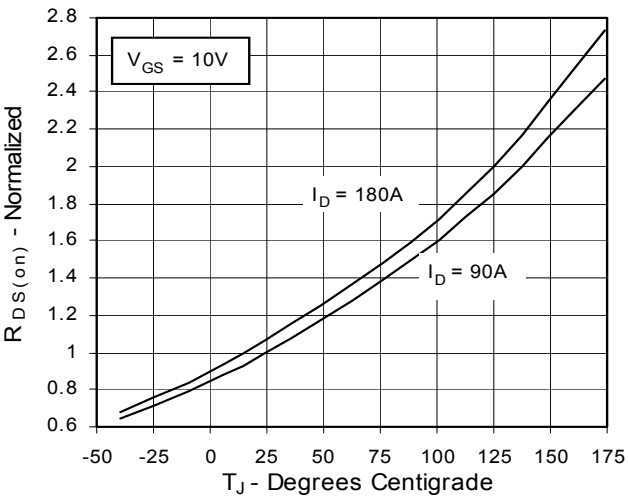


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 90A Value vs. Drain Current

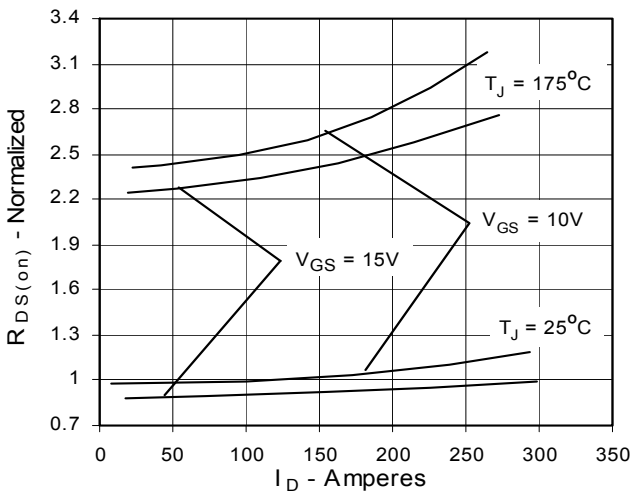


Fig. 6. Drain Current vs. Case Temperature

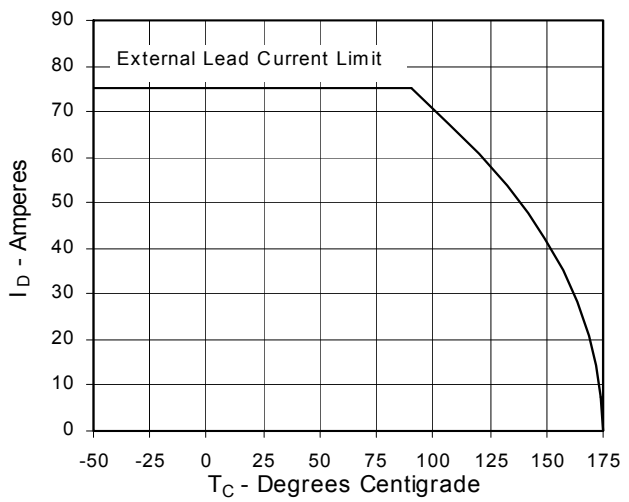


Fig. 7. Input Admittance

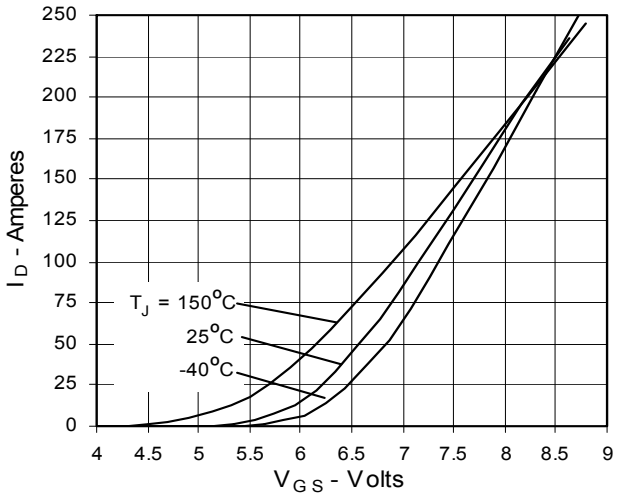


Fig. 8. Transconductance

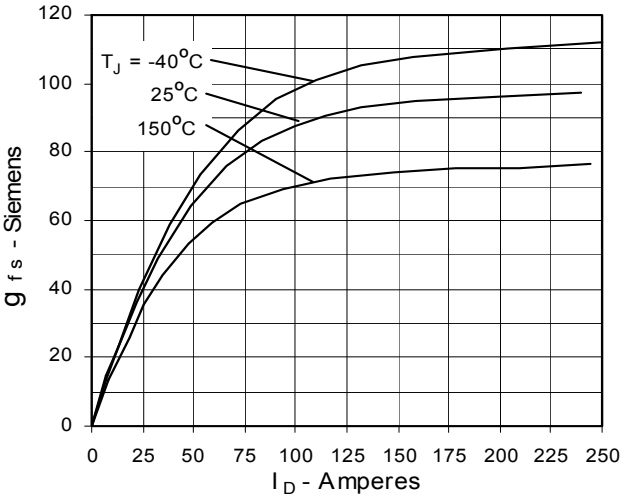


Fig. 9. Source Current vs. Source-To-Drain Voltage

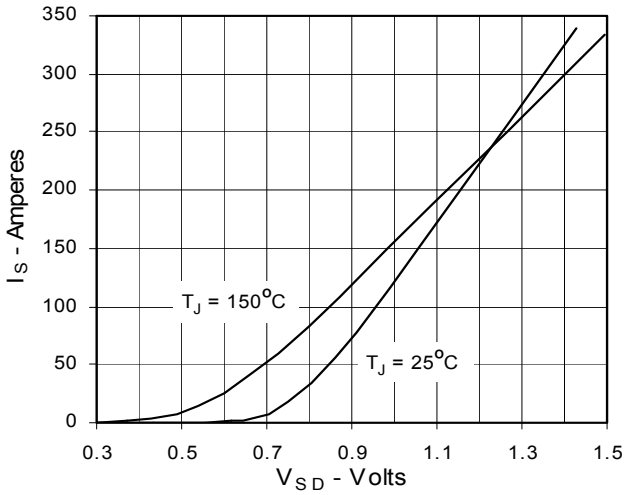


Fig. 10. Gate Charge

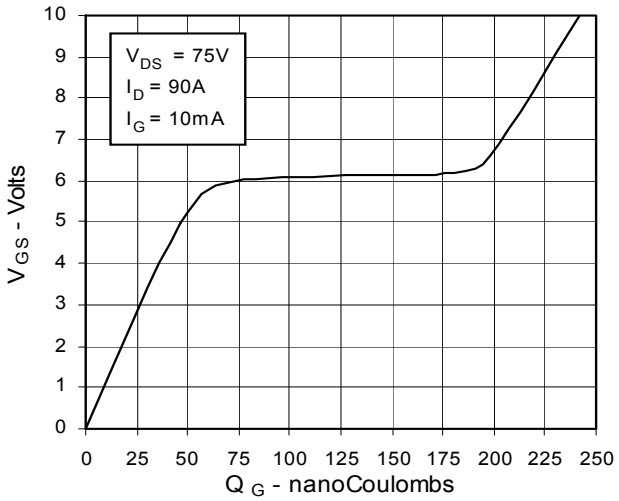


Fig. 11. Capacitance

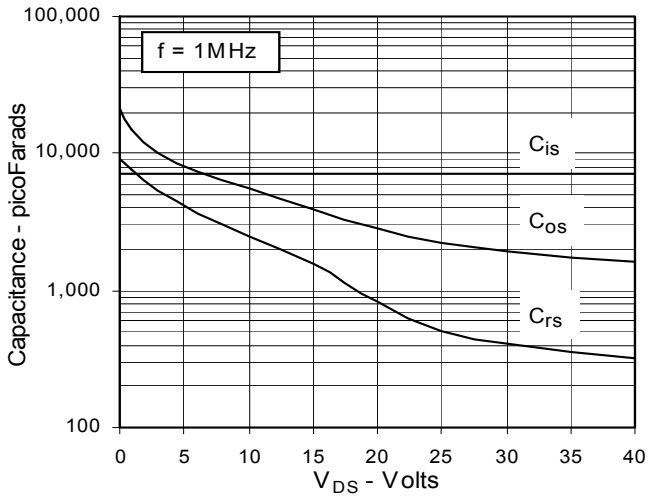


Fig. 12. Forward-Bias Safe Operating Area

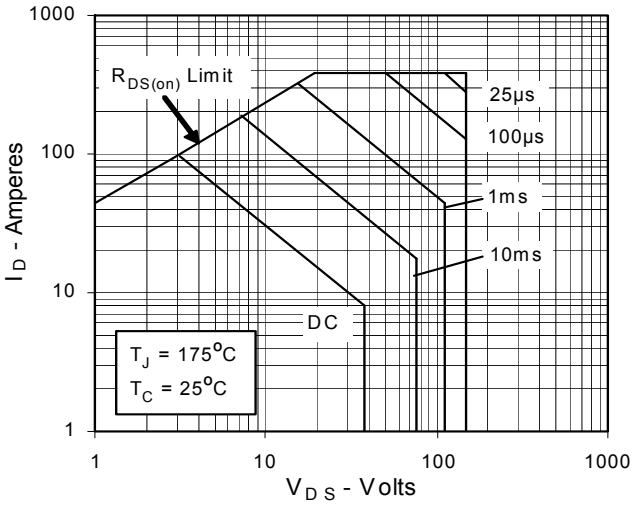
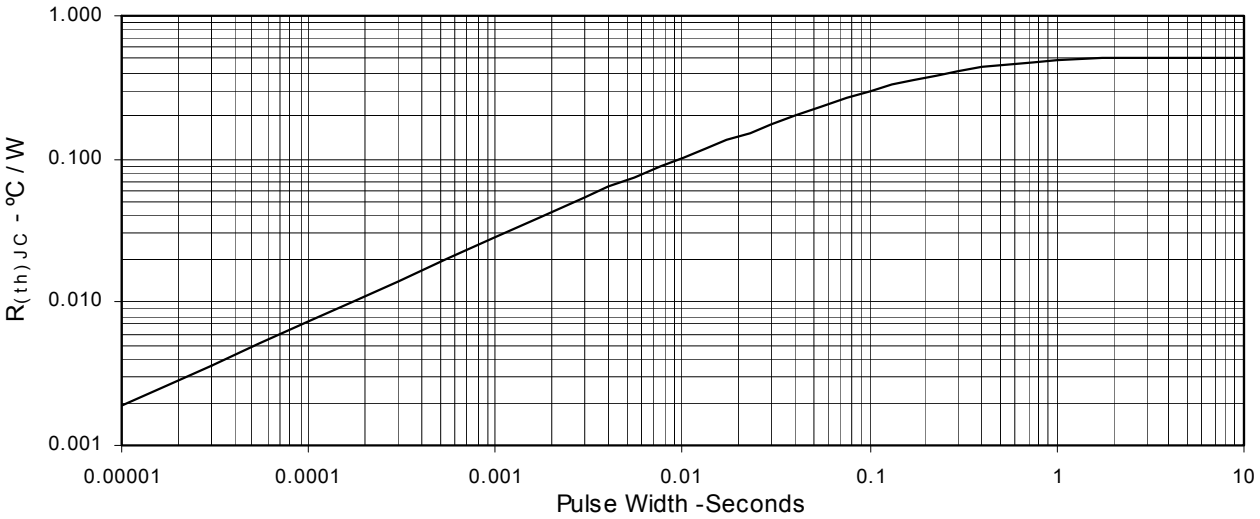


Fig. 13. Maximum Transient Thermal Resistance



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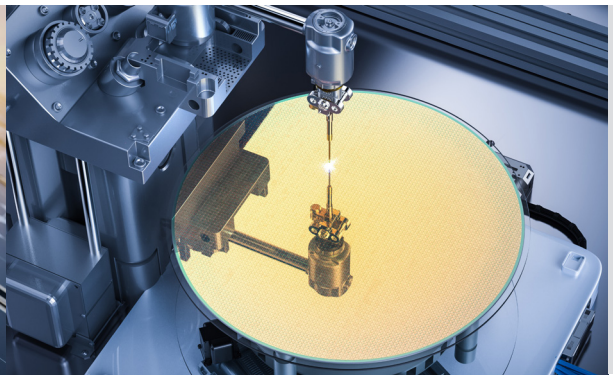
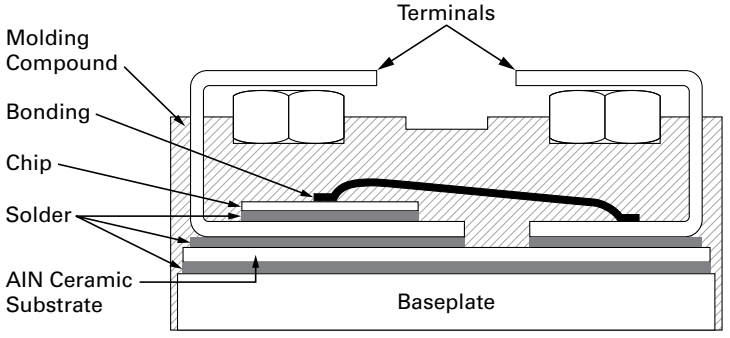


Isolated **mini**ature power **BLOC**K (miniBLOC™) solution for Plasma Power Supplies

Littelfuse's isolated miniBLOC™ (SOT-227B) is a discrete miniature power BLOCK, conveniently bridging the power gap between inexpensive discrete packages and full-sized power modules. Littelfuse offers a wide range of Si and SiC miniBLOC™ MOSFET solutions catering to the design demands of plasma power supplies.

The miniBLOC™ solution offering fully isolated base plate, higher power densities, faster switching speeds, wide device choice, ease of application, and long-term reliability will serve as a key enabler, providing the right solution to development needs at different power levels.



Cross-section of SOT-227B (miniBLOC)

The **mini**ature power **BLOC**K Advantage

Features

- Aluminum Nitride ceramic-based compact discrete package with electrically isolated baseplate
- Reduced overall junction-sink thermal impedance in comparison to non-isolated discretes
- Isolation up to 2.5 kV V_{RMS}/60 s or 3 kV V_{RMS}/1 s
- Extended creepage and clearance distances:
  - Terminal-terminal: clearance of up to 7 mm and creepage of up to 10.5 mm
  - Terminal-baseplate: clearance of up to 8.5 mm and creepage of up to 10.5 mm
- Discrete power block with high current-handling capability
- Low internal lead inductance < 5 nH
- Option for Kelvin-Source terminal
- Screw-mounted discrete package with four screwed terminal leads

Advantages

- Aluminum Nitride internal isolation increases power density, simplifies thermal design, improves reliability, and enables superior power cycling capability with cooler chip temperatures compared to non-isolated and conventionally isolated discretes
- Optimal for high-voltage design given the inherent isolation and extended creepage and clearance
- Reduced paralleling effort and decreased part count resulting in PCB space savings
- Higher safety overvoltage margin with reduced overvoltage stress at chip level due to lower package stray inductance
- Kelvin-Source terminal improves controllability, enabling faster switching speeds
- Rugged and stable mounting, ease of manufacturing and handling in assembly

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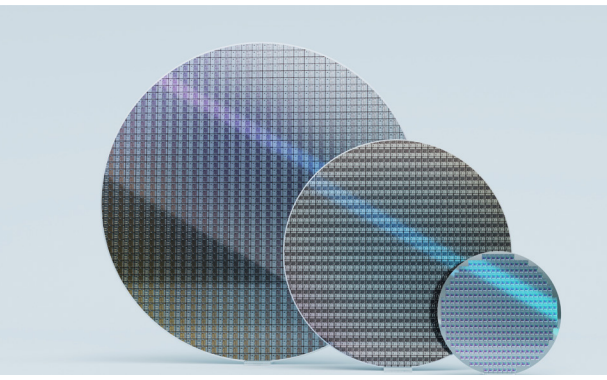
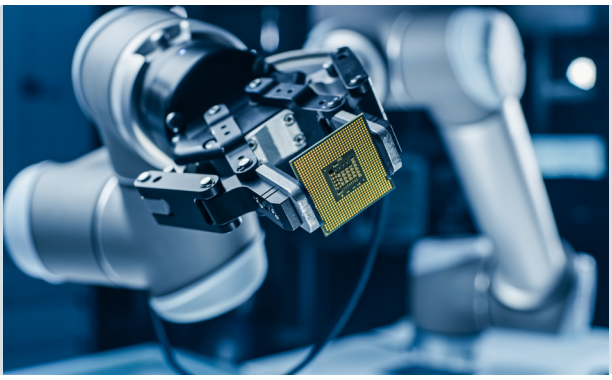
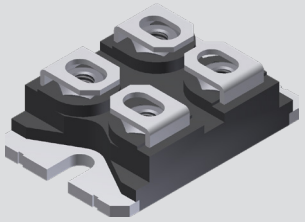






High Current (> 50 A), 650 V Ultra Junction X2-Class MOSFETs in miniBLOC™

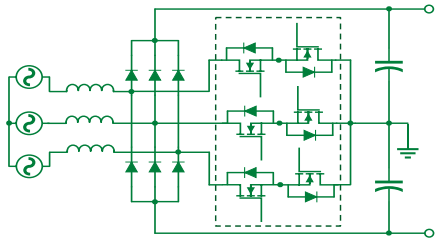
$R_{DS(on),max}$ [mΩ]	I_{D25} [A]	miniBLOC™
13	170	IXFN170N65X2 ●
17	145	IXFN150N65X2 ●
24	108	IXFN120N65X2 ●
30	78	IXFN100N65X2 ●
30	76	IXTN102N65X2 ●

● HiPerFET™ (fast-body diode)
● Standard body diode

The 650 V X2-Class Ultra Junction MOSFETs in miniBLOC™ package from Littelfuse exhibit some of the highest current ratings, lowest on-state resistances $R_{DS(on)}$, low gate charge Q_g, and superior dv/dt performance. Their superior avalanche capability further enhances device ruggedness in critical applications. Additionally, the HiPerFET™ devices with fast soft-recovery body diode have reduced switching losses and a better electromagnetic interference (EMI) behavior.

These benefits of the 650 V Ultra Junction X2-Class MOSFETs in combination with the advantages offered by the miniBLOC™ package make them a preferred choice for plasma power supplies.

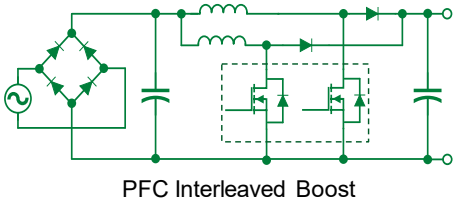
AC Input: 3-Ph, 170 - 480 V, 50/60 Hz; DC Output: 600 - 800 V



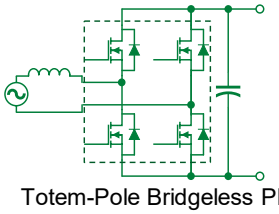
Vienna Rectifier

650 V MOSFETs

AC Input: 1-Ph, 85 - 265 V, 50/60 Hz; DC Output: < 400 V



PFC Interleaved Boost



Totem-Pole Bridgeless PFC

650 V MOSFETs

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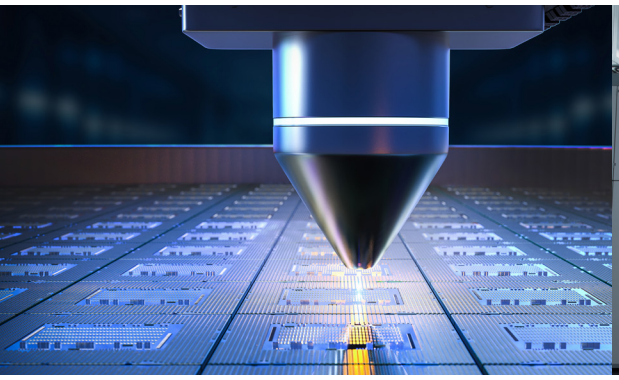


900–1200 V Polar™ HiPerFET™ in miniBLOC™

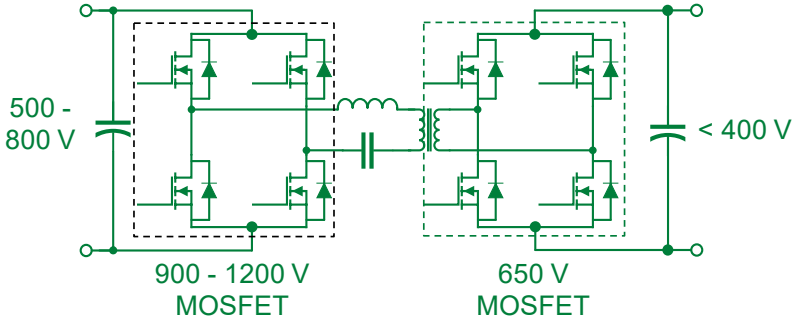
$R_{DS(on),max}$ [Ω]	I_{D25} [A]	V_{DSS} [V]	miniBLOC™
0.145	56	900	IXFN56N90P
0.160	43	900	IXFN52N90P
0.230	33	900	IXFN40N90P
0.21	38	1000	IXFN38N100P
0.22	37	1000	IXFN44N100P
0.32	27	1000	IXFN32N100P
0.39	23	1000	IXFN26N100P
0.26	34	1100	IXFN40N110P
0.31	32	1200	IXFN32N120P
0.35	30	1200	IXFN30N120P
0.46	23	1200	IXFN26N120P
0.57	20	1200	IXFN20N120P

Littelfuse 900–1200 V Polar™ HiPerFET™ devices are tailored to provide designers with a rugged device solution that offers the best advantage in performance and cost in high frequency applications.

These devices incorporate the Polar technology platform to achieve low on-state resistances $R_{DS(on)}$ which improves conduction behavior. The low gate charge Q_g and fast body diode results in more efficient switching at all frequencies. The dv/dt and avalanche capabilities of these devices provide additional safeguards against overvoltage transients.

The benefits of the Polar™ HiPerFET™ devices, in addition to the advantages offered by the miniBLOC™ package, make them the best solution for plasma power supplies.

DC/DC LLC Converter



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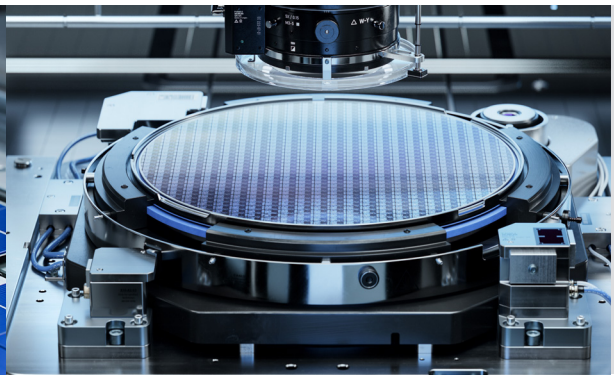
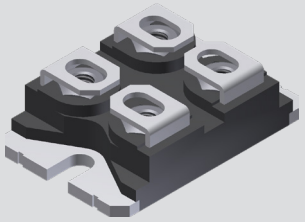




1200 V SiC MOSFETs in miniBLOC™ with Kelvin-Source

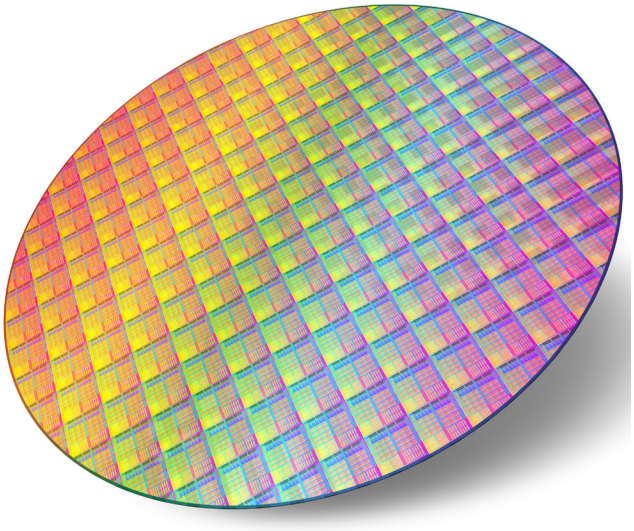
$R_{DS(on),max}$ [mΩ]	I_{D25} [A]	V_{DSS} [V]	miniBLOC™ w/ Kelvin-Source 
10	130	900	IXFN130N90SK
21	75	1200	IXFN75N120SK
32	55	1200	IXFN55N120SK
75	30	1200	IXFN30N120SK

Note: Preliminary datasheet and engineering samples available for the SiC MOSFETs in the table above

Littelfuse 1200 V SiC MOSFETs featuring low $R_{DS(on)}$ and low device capacitances, offer the highest efficiency for reduced cooling effort. The excellent conduction and switching behavior combined with higher frequency operation improves power density in the application.

The SiC MOSFETs in miniBLOC™ featuring a Kelvin-Source connection offer superior immunity to parasitic turn-on/turn-off events, thereby maximizing the high-speed switching performance of the MOSFET.

These advantages of SiC MOSFETs combined with the benefits offered by the miniBLOC™ package make them a preferred choice in Plasma Power Supplies.



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